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APPLICANT
Walter et al.

(Use several sheets if necessary)

FILING DATE
October 3, 2003

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U.S. PATENT DOCUMENTS

EXAMINE R INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
JT	6 4 4 0 9 0 4	08/27/02	Chen et al.	505	236	10/23/98

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
JT	1 9 8 3 2 2 73	11/11/99	Germany				
JT	4 0 0 4 9 0 8	08/22/91	Germany				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

JT		"Thermal contact resistance between high-T Superconductor and Copper" by Fujishiro et al. Faculty of Engineering, Iwate University, 4-3-5 Morioka 020-8551, Japan, 01/17/01
JT		European Search Report dated March 11, 2003

EXAMINER

DATE CONSIDERED

7/5/2006

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.